

# REALTEK

**RTL8187L**  
**RTL8187L-LF**

## **WIRELESS LAN NETWORK INTERFACE CONTROLLER**

### **DATASHEET**

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This document is intended for the software engineer’s reference and provides detailed programming information.

Though every effort has been made to ensure that this document is current and accurate, more information may have become available subsequent to the production of this guide. In that event, please contact your Realtek representative for additional information that may help in the development process.

**REVISION HISTORY**

<b>Revision</b>	<b>Release Date</b>	<b>Summary</b>
1.0	2004/10/22	First release.
1.1	2005/04/25	Revised data transaction content. Added offset 8 information (Table 27, page 23, and Table 28, page 23).
1.2	2005/09/06	Added RoHS declaration (see last 2 pages). Added lead (Pb)-free and package identification information on page 4. Corrected section 14 Mechanical Dimensions, page 34.

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## 1. General Description

The Realtek RTL8187L is a low-profile highly integrated cost-effective Wireless LAN USB 2.0 network interface controller that integrates a USB 2.0 PHY, SIE (Serial Interface Engine), 8051 MCU, a Wireless LAN MAC, and a Direct Sequence Spread Spectrum/OFDM baseband processor onto one chip. It provides USB high speed (480Mbps), and full speed (12Mbps), and supports 4 endpoints for transfer pipes. To reduce protocol overhead, the RTL8187L supports Short InterFrame Space (SIFS) burst mode to send packets back-to-back. A protection mechanism prevents collisions among 802.11b nodes. The RTL8187L fully complies with IEEE 802.11a/b/g specifications.

Direct Sequence Spread Spectrum (DSSS), Complementary Code Keying (CCK), and Orthogonal Frequency Division Multiplexing (OFDM) baseband processing are implemented to support all IEEE 802.11a, 802.11b, and 802.11g data rates. Differential phase shift keying modulation schemes, DBPSK and DQPSK with data scrambling capability, are available, along with complementary code keying to provide data rates of 1, 2, 5.5, and 11Mbps, with long or short preamble. A high-speed Fast Fourier Transform (FFT)/Inverse Fast Fourier Transform (IFFT), combined with BPSK, QPSK, 16QAM and 64QAM modulation of the individual sub-carriers, provides data rates of 6, 9, 12, 18, 24, 36, 48 and 54Mbps, with rate-compatible punctured convolutional coding with a coding rate of 1/2, 2/3, and 3/4.

An enhanced signal detector, an adaptive frequency domain equalizer, and a soft-decision Viterbi decoder are built-in to alleviate severe multipath effects. Efficient IQ-imbalance calibration, DC offset, phase noise, frequency offset, and timing offset compensation reduce radio frequency front-end impairments. Selectable digital transmit and receiver FIR filters are provided to meet the requirements of transmit spectrum masks, and to reject adjacent channel interference, respectively. Both in the transmitter and receiver, programmable scaling in the digital domain trades the quantization noise against the increased probability of clipping. Robust signal detection, symbol boundary detection, and channel estimation perform well at the minimum sensitivity.

The RTL8187L supports fast receiver Automatic Gain Control (AGC) and antenna diversity functions, and an adaptive transmit power control function to obtain better performance in the analog portions of the transceiver. It also has on-chip digital-to-analog converters and analog-to-digital converters for analog I and Q inputs and outputs, transmit TSSI and receiver RSSI inputs, and transmit and receiver AGC outputs.

The RTL8187L is highly integrated and requires no 'glue' logic or external memory. It keeps network maintenance costs low and eliminates usage barriers.

## 2. Features

- 128-Pin LQFP and 128-pin LQFP Lead (Pb)-Free package
- State machine implementation without external memory (RAM, flash) requirement
- Complies with IEEE 802.11a/b/g standards
- Supports descriptor-based buffer management
- Integrated Wireless LAN MAC and Direct Sequence Spread Spectrum/OFDM Baseband Processor in one chip
- Enhanced signal detector, adaptive frequency domain equalizer, and soft-decision Viterbi decoder to alleviate severe multipath effects
- Processing Gain compliant with FCC
- On-Chip A/D and D/A converters for I/Q Data, AGC, and Adaptive Power Control
- Supports both transmit and receive Antenna Diversity
- Data rates of 1, 2, 5.5, 6, 9, 11, 12, 18, 24, 36, 48, and 54Mbps
- Supports 40MHz OSC as the internal clock source. The frequency deviation of the OSC must be within 25 PPM on IEEE 802.11g and 20 PPM on IEEE 802.11a
- IEEE 802.11g protection mechanisms for both RTS/CTS and CTS-to-self
- Burst-mode support for dramatically enhanced throughput
- DSSS with DBPSK and DQPSK, CCK modulations and demodulations supported with long and short preamble
- OFDM with BPSK, QPSK, 16QAM and 64QAM modulations and demodulations supported with rate compatible punctured convolutional coding with coding rate of 1/2, 2/3, and 3/4
- Efficient IQ-imbalance calibration, DC offset, phase noise, frequency offset and timing offset compensation reduce analog front-end impairments
- Selectable digital transmit and receiver FIR filters provided to meet transmit spectrum mask requirements and to reject adjacent channel interference
- Programmable scaling both in transmitter and receiver to trade quantization noise against the increased probability of clipping
- Fast receiver Automatic Gain Control (AGC) & antenna diversity functions
- Hardware-based IEEE 802.11i encryption/decryption engine, including 64-bit/128-bit WEP, TKIP, and AES
- Supports Wi-Fi alliance WPA and WPA2 security
- Contains two large independent transmit and receive FIFO buffers
- Advanced power saving mode when the LAN and wakeup function are not used
- Uses 93C46 (64\*16-bit EEPROM) or 93C56 (128\*16-bit EEPROM) to store resource configuration and ID parameter data
- LED pins for various network activity indications
- Two GPIO pins supported

- Supports digital loopback capability on both ports
- Scatter and gather operation
- Complies with USB Specification 2.0
  - ◆ Supports Full-speed (12Mbps) and High-speed (480Mbps)
- Embedded standard 8051 CPU with enhanced features:
  - ◆ Four cycles per instruction
  - ◆ Variable clock speed cuts power consumption
- Supports 4 endpoints:
  - ◆ 64-Byte buffer for control endpoint
  - ◆ 512-Byte buffer for bulk IN endpoint
  - ◆ Two 512-Byte buffers for bulk OUT endpoint
- 3.3V and 1.8V power supplies required
- 5V tolerant I/Os
- 0.18 $\mu$ m CMOS process

### 3. System Applications

- USB Dongle WLAN adapter
- Embedded WLAN solution in notebook, desktop, mobile phone, and motherboard



## 4. Block Diagram

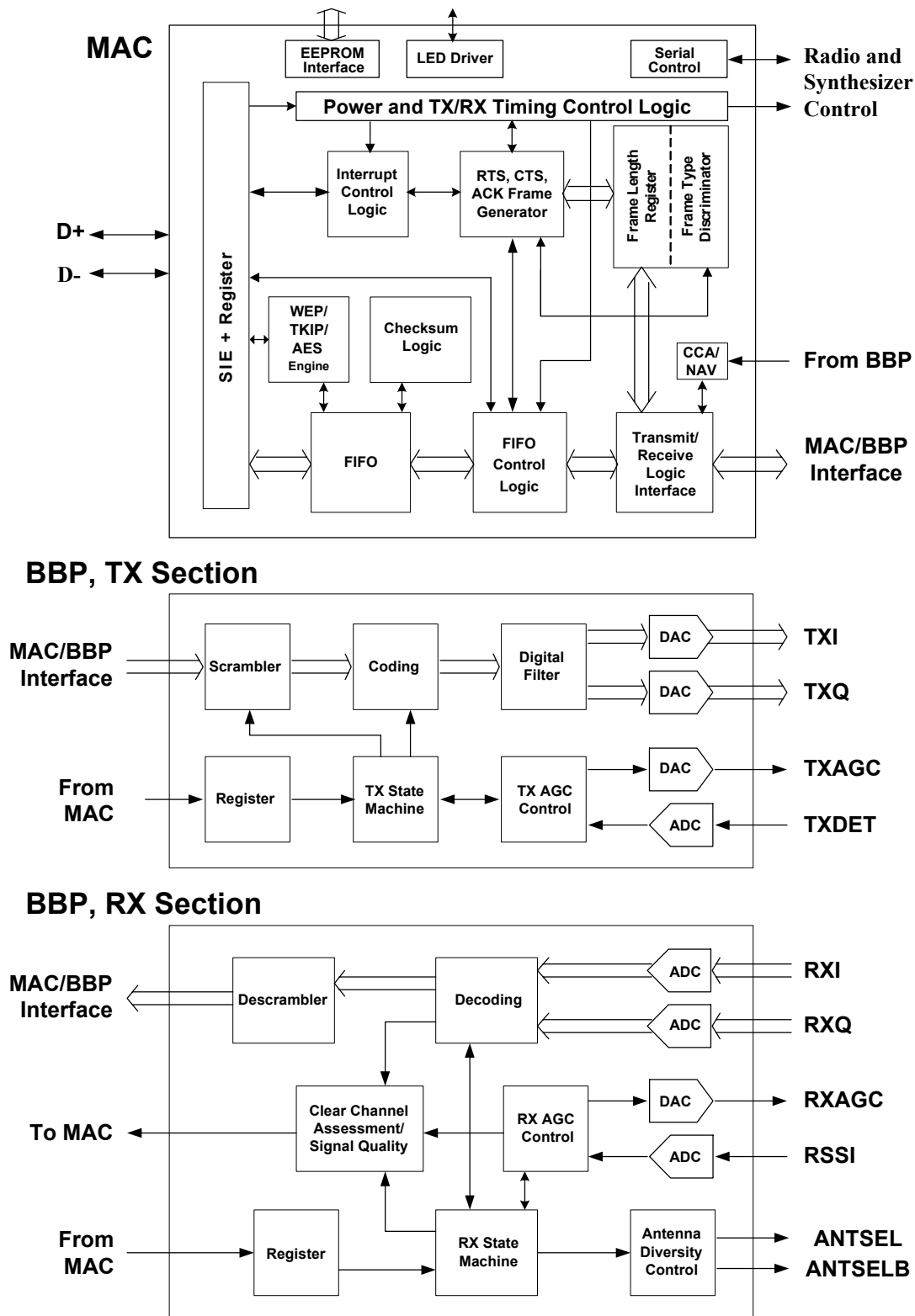


Figure 1. Block Diagram

## 5. Pin Assignments

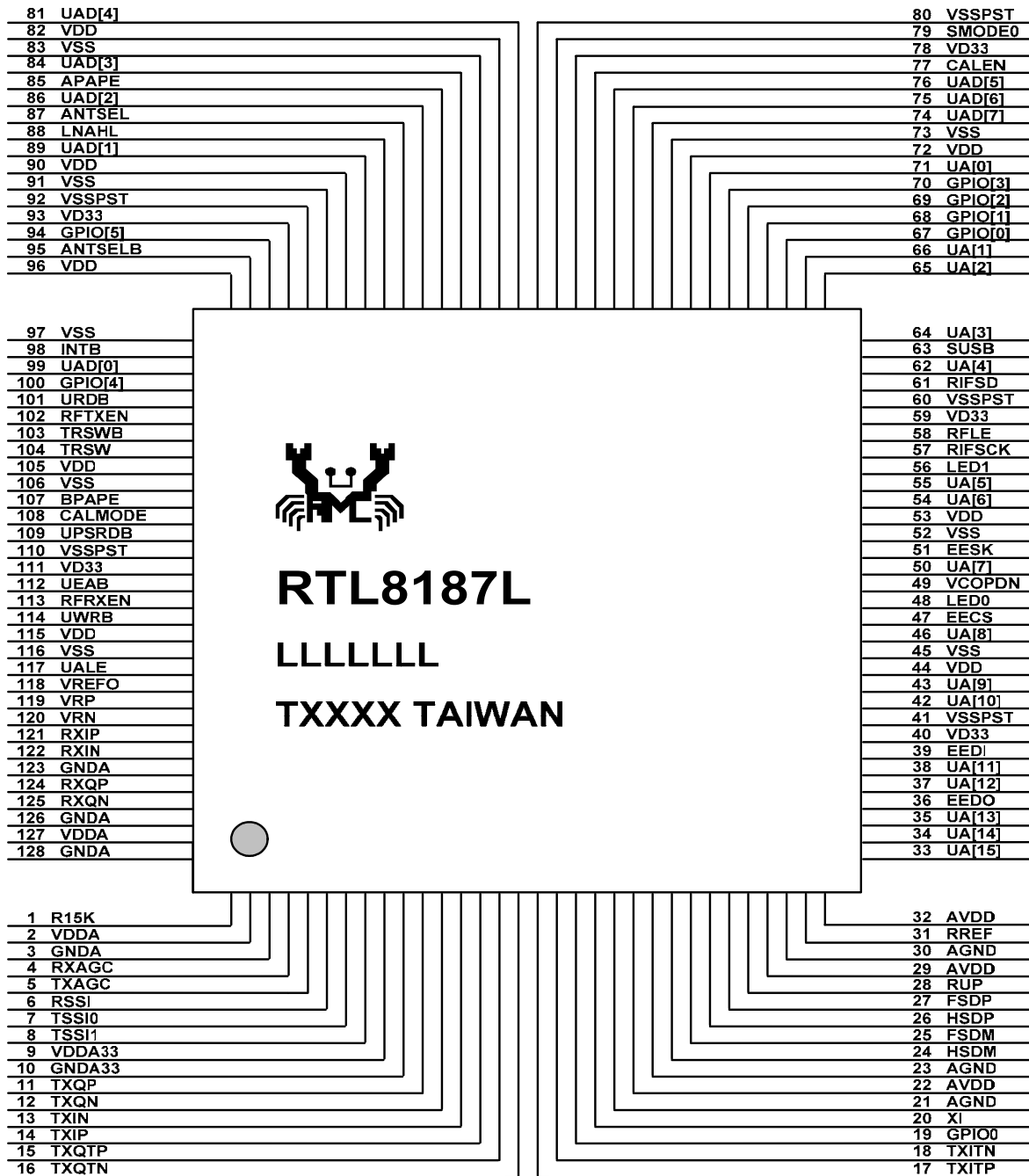


Figure 2. Pin Assignments

### 5.1. Lead (Pb)-Free Package Identification

Lead (Pb)-free package is indicated by an 'L' in the location marked 'T' in Figure 2.

## 6. Pin Descriptions

In order to reduce pin count, and therefore size and cost, some pins have multiple functions. In such cases, the functions are separated with a '/' symbol. Refer to the Pin Assignments diagram on page 4 for a graphical representation.

The following signal type codes are used in the tables:

I: Input.

S/T/S: Sustained Tri-State.

O: Output

O/D: Open Drain.

T/S: Tri-State bi-directional input/output pin.

### 6.1. USB Transceiver Interface

**Table 1. USB Transceiver Interface**

Symbol	Type	Pin No	Description
HSDP	I/O	26	High speed USB D+ signal
HSDM	I/O	24	High speed USB D- signal
FSDP	I/O	27	Full speed USB D+ signal
FSDM	I/O	25	Full speed USB D- signal
RUP	N/A	28	External pull-up resistor (1.5k $\Omega$ ) for D+ line.
RREF	N/A	31	External Reference. Requires 1% precision 6.25K resistor to ground

### 6.2. EEPROM Interface

**Table 2. EEPROM Interface**

Symbol	Type	Pin No	Description
EESK	O	51	EESK in 93C46 (93C56) programming or auto-load mode.
EEDI	O	39	EEDI in 93C46 (93C56) programming or auto-load mode.
EEDO	I/O	36	EEDO in 93C46 (93C56) programming or auto-load mode.
EECS	O	47	EEPROM Chip Select. 93C46 (93C56) chip select.

### 6.3. Power Pins

**Table 3. Power Pins**

Symbol	Type	Pin No	Description
VDD33	P	40, 59, 78, 93, 111	+3.3V (Digital).
AVDD	P	2, 9, 22, 29, 32, 127	+3.3V (Analog).
VDD	P	44, 53, 72, 82, 90, 96, 105, 115	+1.8V.
GND	P	41, 45, 52, 60, 73, 80, 83, 91, 110	Ground (Digital).
AGND	P	3, 10, 21, 23, 30, 123, 126, 128	Ground (Analog).

## 6.4. LED Interface

**Table 4. LED Interface**

Symbol	Type	Pin No	Description															
LED0, 1	O	48, 56	LED Pins (Active low)															
			<table border="1"> <thead> <tr> <th>LEDS1~0</th> <th>00</th> <th>01</th> <th>10</th> <th>11</th> </tr> </thead> <tbody> <tr> <td>LED0</td> <td>TX/RX</td> <td>TX/RX</td> <td>TX</td> <td>LINK/ACT</td> </tr> <tr> <td>LED1</td> <td>Infrastructure</td> <td>LINK</td> <td>RX</td> <td>Infrastructure</td> </tr> </tbody> </table>	LEDS1~0	00	01	10	11	LED0	TX/RX	TX/RX	TX	LINK/ACT	LED1	Infrastructure	LINK	RX	Infrastructure
LEDS1~0	00	01	10	11														
LED0	TX/RX	TX/RX	TX	LINK/ACT														
LED1	Infrastructure	LINK	RX	Infrastructure														
During power down mode, the LED signals are logic high.																		

## 6.5. Attachment Unit Interface

### 6.5.1. RTL8225 RF Chipset

**Table 5. Attachment Unit Interface**

Symbol	Type	Pin No	Description
RIFSCK	O	57	Serial Clock Output. For the RTL8225 RF chipset, all operation mode switching and register setting is done via a 4-wire serial interface.
RIFSD	I/O	61	Serial Data Input/Output.
RFLE	O	58	Serial Enable control.
CALEN	O	77	Serial Read/Write control.
CALMODE	O	108	Receiver Output. I and Q channel AC coupling high-pass corner frequency selection. The output function of this pin is not used in the RTL8225 RF chipset.
LNA_HL	O	88	Not used in the RTL8225 RF chipset.
ANTSEL	O	87	Antenna Select. The antenna detects signal change states as the receiver switches from antenna to antenna during the acquisition process in antenna diversity mode. This is a complement for ANTSELB for differential drive of antenna switches.
ANTSELB	O	95	Antenna Select B. The antenna detects signal change states as the receiver switches from antenna to antenna during the acquisition process in the antenna diversity mode. This is a complement for ANTSEL for differential drive of antenna switches.
TRSW	O	104	Transmit/Receive path select.
TRSWB	O	103	The TRSW select signal controls the direction of the Transmit/Receive switch.
VCOPDN	O	49	Output Pin as shutdown mode select digital input.
A_PAPE	O	85	2.4GHz Transmit Power Amplifier Power Enable.
B_PAPE	O	107	Not used in the RTL8225 RF chipset.
RFTXEN	O	102	Not used in the RTL8225 RF chipset.
RFRXEN	O	113	Not used in the RTL8225 RF chipset.
GPIO0	O	67	General purpose input/output pin.
GPIO1	O	68	General purpose input/output pin.
GPIO2	O	69	General purpose input/output pin.
GPIO3	O	70	General purpose input/output pin.

Symbol	Type	Pin No	Description
GPIO4	O	100	General purpose input/output pin.
GPIO5	O	94	General purpose input/output pin.
VREFO	X	118	Not used in the RTL8225 RF chipset.
VRP	X	119	Not used in the RTL8225 RF chipset.
VRN	X	120	Not used in the RTL8225 RF chipset.
RXIP	I	121	Receive (Rx) In-phase Analog Data.
RXIN	I	122	
RXQP	I	124	Receive (Rx) Quadrature-phase Analog Data.
RXQN	I	125	
RXAGC	I	4	Not used in the RTL8225 RF chipset.
TXAGC	O	5	Not used in the RTL8225 RF chipset.
RSSI	I	6	Analog Input to the Receive Power A/D Converter for Receive AGC Control.
TSSIO	I	7	Input to the Transmit Power A/D Converter for 2.4GHz Transmit AGC Control.
TSSII	I	8	Not used in the RTL8225 RF chipset.
TXQP	I	11	Not used in the RTL8225 RF chipset.
TXQN	I	12	
TXIP	O	14	Not used in the RTL8225 RF chipset.
TXIN	O	13	
TXQTP	O	15	Transmit (TX) Quadrature-phase Analog Data.
TXQTN	O	16	
TXITP	O	17	Transmit (TX) In-phase Analog Data.
TXITN	O	18	

## 6.5.2. RTL8255 RF Chipset

**Table 6. RTL8255 RF Chipset**

Symbol	Type	Pin No	Description
RIFSCK	O	57	Serial Clock Output. For the RTL8255 RF chipset, all operation mode switching and register setting is done via a 3-wire serial interface.
RIFSD	O	61	Serial Data Input/Output.
RFLE	O	58	Serial Enable control.
CALEN	X	77	Not used in the RTL8255 RF chipset.
CALMODE	O	108	Receiver Output. I and Q channel AC coupling high-pass corner frequency selection. The output function of this pin is not used in the RTL8255 RF chipset.
LNAHL	O	88	Not used in the RTL8255 RF chipset.
ANTSEL	O	87	Antenna Select. The antenna detects signal change states as the receiver switches from antenna to antenna during the acquisition process in antenna diversity mode.
ANTSELB	O	95	
TRSW	O	104	Transmit/Receive path select.
TRSWB	O	103	The TRSW select signal controls the direction of the Transmit/Receive switch.
VCOPDN	O	49	Not used in the RTL8255 RF chipset.
APAPE	O	85	2.4GHz Transmit Power Amplifier Power Enable.
BPAPE	O	107	5GHz Transmit Power Amplifier Power Enable.

Symbol	Type	Pin No	Description
RFTXEN	O	102	Not used in the RTL8255 RF chipset.
RFRXEN	O	113	Not used in the RTL8255 RF chipset.
GPIO[0]	O	67	General purpose input/output pin.
GPIO[1]	O	68	General purpose input/output pin.
GPIO[2]	O	69	General purpose input/output pin.
GPIO[3]	O	70	General purpose input/output pin.
GPIO[4]	O	100	General purpose input/output pin.
GPIO[5]	O	94	General purpose input/output pin.
VREFO	X	118	Not used in the RTL8255 RF chipset.
VRP	X	119	Not used in the RTL8255 RF chipset.
VRN	X	120	Not used in the RTL8255 RF chipset.
RXIP	I	121	Receive (Rx) In-phase Analog Data.
RXIN	I	122	
RXQP	I	124	Receive (Rx) Quadrature-phase Analog Data.
RXQN	I	125	
RXAGC	O	4	Not used in the RTL8255 RF chipset.
TXAGC	O	5	Not used in the RTL8255 RF chipset.
RSSI	I	6	Analog Input to the Receive Power A/D Converter for Receive AGC Control.
TSSIO	I	7	Input to the Transmit Power A/D Converter for 2.4GHz Transmit AGC Control.
TSSII	I	8	Input to the Transmit Power A/D Converter for 5GHz Transmit AGC Control.
TXQP	O	11	Transmit (TX) Quadrature-phase Analog Data.
TXQN	O	12	
TXIP	O	14	Transmit (TX) In-phase Analog Data.
TXIN	O	13	
TXQTP	O	15	Not used in the RTL8255 RF chipset.
TXQTN	O	16	
TXITP	O	17	Not used in the RTL8255 RF chipset.
TXITN	O	18	

## 6.6. Clock and Other Pins

**Table 7. Clock and Other Pins**

Symbol	Type	Pin No	Description
R15K	I/O	1	This pin must be pulled low by a 15K $\Omega$ resistor.
XI	I	20	40MHz OSC Input.

## **7. CPU Access to Endpoint Data**

### ***7.1. Control Transfer***

Control transfers configure and send commands to a device. Because they are so important, they employ extensive USB error checking. The host reserves a portion of each USB frame for control transfers. Control transfers consist of two or three stages. The SETUP stage contains eight bytes of USB control data. An optional DATA stage contains more data, if required. The STATUS stage allows the device to indicate successful completion of a control operation.

### ***7.2. Bulk Transfer***

Bulk data is bursty, traveling in packets of 8, 16, 32, or 64 bytes at full speed, or at 512 bytes at high speed. Bulk data has guaranteed accuracy due to an automatic retry mechanism for erroneous data. The host schedules bulk packets when there is available bus time.

## 8. USB Request

### 8.1. Get Descriptor-Device

Table 8. Get Descriptor-Device

#### Setup Transaction

BmReq	bReq	wValueL	wValueH	wIndexL	wIndexH	wLengthL	wLengthH
80	06	00	01	00	00	Length_L	Length_H

#### High Speed Data Transaction

DATA0	DATA1	DATA2	DATA3	DATA4	DATA5	DATA6	DATA7
12	01	00	02	00	00	00	40
DA	0B	87	81	00	01	01	02
03	01						

#### Full Speed Data Transaction

DATA0	DATA1	DATA2	DATA3	DATA4	DATA5	DATA6	DATA7
12	01	10	01	00	00	00	40
DA	0B	87	81	00	01	01	02
03	01						

### 8.2. Get Descriptor-Device Qualifier (High Speed)

Table 9. Get Descriptor- Device Qualifier (High Speed)

#### Setup Transaction

BmReq	bReq	wValueL	wValueH	wIndexL	wIndexH	wLengthL	wLengthH
80	06	00	06	00	00	Length_L	Length_H

#### Data Transaction

DATA0	DATA1	DATA2	DATA3	DATA4	DATA5	DATA6	DATA7
0A	06	00	02	00	00	00	40
01	00						



### 8.3. Get Descriptor-Configuration

**Table 10. Get Descriptor-Configuration**
**Setup Transaction**

BmReq	bReq	wValueL	wValueH	wIndexL	wIndexH	wLengthL	wLengthH
80	06	00	02	00	00	Length_L	Length_H

**High Speed Data Transaction**

DATA0	DATA1	DATA2	DATA3	DATA4	DATA5	DATA6	DATA7
09	02	27	00	01	01	04	80
FA	09	04	00	00	03	00	00
00	05	07	05	81	02	00	02
00	07	05	02	02	00	02	00
07	05	03	02	00	02	00	

**Full Speed Data Transaction**

DATA0	DATA1	DATA2	DATA3	DATA4	DATA5	DATA6	DATA7
09	02	27	00	01	01	00	E0
01	09	04	00	00	03	00	00
00	05	07	05	81	02	40	00
00	07	05	02	02	40	00	00
07	05	03	02	40	00	00	

### 8.4. Get Descriptor-String Index 0

**Table 11. Get Descriptor-String Index 0**
**Setup Transaction**

BmReq	bReq	wValueL	wValueH	wIndexL	wIndexH	wLengthL	wLengthH
80	06	00	03	00	00	Length_L	Length_H

**Data Transaction**

DATA0	DATA1	DATA2	DATA3	DATA4	DATA5	DATA6	DATA7
04	03	09	04	-	-	-	-

## 8.5. Get Descriptor-String Index 1

**Table 12. Get Descriptor-String Index 1**
**Setup Transaction**

BmReq	bReq	wValueL	wValueH	wIndexL	wIndexH	wLengthL	wLengthH
80	06	01	03	09	04	Length_L	Length_H

**Data Transaction**

DATA0	DATA1	DATA2	DATA3	DATA4	DATA5	DATA6	DATA7
10	03	52	00	65	00	61	00
6C	00	74	00	65	00	6B	00

## 8.6. Get Descriptor-String Index 2

**Table 13. Get Descriptor-String Index 2**
**Setup Transaction**

BmReq	bReq	wValueL	wValueH	wIndexL	wIndexH	wLengthL	wLengthH
80	06	02	03	09	04	Length_L	Length_H

**Data Transaction**

DATA0	DATA1	DATA2	DATA3	DATA4	DATA5	DATA6	DATA7
3A	03	52	00	54	00	4C	00
38	00	31	00	38	00	37	00
20	00	57	00	59	00	72	00
65	00	6C	00	65	00	73	00
73	00	20	00	4C	00	41	00
4E	00	20	00	41	00	64	00
61	00	70	00	74	00	65	00
72	00						

## 8.7. Get Descriptor-String Index 3

**Table 14. Get Descriptor-String Index 3**
**Setup Transaction**

BmReq	bReq	wValueL	wValueH	wIndexL	wIndexH	wLengthL	wLengthH
80	06	03	03	09	04	Lengh_L	Length_H

**Data Transaction**

DATA0	DATA1	DATA2	DATA3	DATA4	DATA5	DATA6	DATA7
1A	03	30	00	30	00	65	00
30	00	34	00	63	00	30	00
30	00	30	00	30	00	30	00
31	00						

## 8.8. Get Descriptor-String Index 4

**Table 15. Get Descriptor-String Index 4**
**Setup Transaction**

BmReq	bReq	wValueL	wValueH	wIndexL	wIndexH	wLengthL	wLengthH
80	06	04	03	09	04	Lengh_L	Length_H

**Data Transaction**

DATA0	DATA1	DATA2	DATA3	DATA4	DATA5	DATA6	DATA7
2C	03	57	00	69	00	72	00
65	00	6C	00	65	00	73	00
73	00	20	00	4E	00	65	00
74	00	77	00	6F	00	72	00
6B	00	20	00	43	00	61	00
72	00	64	00				

## 8.9. Get Descriptor-String Index 5

**Table 16. Get Descriptor-String Index 5**
**Setup Transaction**

BmReq	bReq	wValueL	wValueH	wIndexL	wIndexH	wLengthL	wLengthH
80	06	05	03	09	04	Length_L	Length_H

**Data Transaction**

DATA0	DATA1	DATA2	DATA3	DATA4	DATA5	DATA6	DATA7
34	03	42	00	75	00	6C	00
6B	00	2D	00	49	00	4E	00
2C	00	42	00	75	00	6C	00
6B	00	2D	00	4F	00	55	00
54	00	2C	00	42	00	75	00
6C	00	6B	00	2D	00	4F	00
55	00	54	00				

## 8.10. Get Descriptor-Other Speed Configuration

**Table 17. Get Descriptor-Other Speed Configuration**
**Setup Transaction**

BmReq	bReq	wValueL	wValueH	wIndexL	wIndexH	wLengthL	wLengthH
80	06	00	07	00	00	Length_L	Length_H

**High Speed Data Transaction**

DATA0	DATA1	DATA2	DATA3	DATA4	DATA5	DATA6	DATA7
09	02	27	00	01	01	04	80
FA	09	04	00	00	03	00	00
00	05	07	05	81	02	00	02
00	07	05	02	02	00	02	00
07	05	03	02	00	02	00	

**Full Speed Data Transaction**

DATA0	DATA1	DATA2	DATA3	DATA4	DATA5	DATA6	DATA7
09	02	27	00	01	01	00	E0
01	09	04	00	00	03	00	00
00	05	07	05	81	02	40	00
00	07	05	02	02	40	00	00
07	05	03	02	40	00	00	

## 8.11. Set Address

**Table 18. Set Address**
**Setup Transaction**

BmReq	bReq	wValueL	wValueH	wIndexL	wIndexH	wLengthL	wLengthH
00	05	addrL	addrH	00	00	00	00

*Note: No data transaction.*

## 8.12. Set Interface 0

**Table 19. Set Interface 0**
**Setup Transaction**

BmReq	bReq	wValueL	wValueH	wIndexL	wIndexH	wLengthL	wLengthH
01	0B	00	00	00	00	00	00

*Note: No data transaction.*

## 8.13. Set Feature Device

**Table 20. Set Feature Device**
**Setup Transaction**

BmReq	bReq	wValueL	wValueH	wIndexL	wIndexH	wLengthL	wLengthH
00	03	01	00	00	00	00	00

*Note: No data transaction.*

## 8.14. Clear Feature Device

**Table 21. Clear Feature Device**
**Setup Transaction**

BmReq	bReq	wValueL	wValueH	wIndexL	wIndexH	wLengthL	wLengthH
00	01	01	00	00	00	00	00

*Note: No data transaction.*

## 8.15. Set Config 0

**Table 22. Set Config 0**
**Setup Transaction**

BmReq	bReq	wValueL	wValueH	wIndexL	wIndexH	wLengthL	wLengthH
00	09	00	02	00	00	00	00

*Note: No data transaction.*

## 8.16. Set Config 1

**Table 23. Set Config 1**
**Setup Transaction**

BmReq	bReq	wValueL	wValueH	wIndexL	wIndexH	wLengthL	wLengthH
00	09	01	00	00	00	00	00

*Note: No data transaction.*

## 9. EEPROM (93C46 or 93C56) Contents

The RTL8187L supports the attachment of an external EEPROM. The 93C46 is a 1Kbit EEPROM (the 93C56 is a 2Kbit EEPROM). The EEPROM interface provides the ability for the RTL8187L to read from, and write data to, an external serial EEPROM device. If the EEPROM is not present, the RTL8187L initialization uses default values for the Operational Registers. Software can read and write to the EEPROM using “bit-bang” accesses via the 9346CR Register.

Although it is actually addressed by words, its contents are listed below by bytes for convenience. After the initial power on or auto-load command in the 9346CR, the RTL8187L performs a series of EEPROM read operations from the 93C46 (93C56).

*Note: It is suggested to obtain Realtek approval before changing the default settings of the EEPROM.*

**Table 24. EEPROM (93C46 or 93C56) Contents**

Bytes	Contents	Description
00h	87h	These 2 bytes contain the ID code word for the RTL8187L. The RTL8187L will load the contents of the EEPROM into the corresponding location if the ID word (8187h) is correct.
01h	81h	
02h-03h	VID	USB Vendor ID.
04h-05h	DID	USB Device ID.
06h	ChannelPlan	Channel Plan: Map of channels to be scanned.
07h	EnergyDetThr	Energy detection threshold.
08h	RFParm	RF specific parameter.
09h-0Ah	Version	The version of EEPROM content.
0Bh	Options function	Bit0: Timeout function. 0: Disable RTL8187L’s USB timeout mechanism. 1: Enable RTL8187L’s USB timeout mechanism.  Bit1: USB remote wake up function. 0: There is no remote wake up feature for the RTL8187L. 1: There is a remote wake up feature for the RTL8187L.  Bit2: 0: The RTL8187L’s remote wake-up is based on the WLAN’s wake-up signal 1: The RTL8187L’s remote wake-up is push-button based.  Bit3: USB Status stage. 1: Bypass the check setup interrupt procedure of 8051 when host sends set_address command.  Bit4: SelfloopbackISR function. 1: The UTM self loopback will be initialized by internal 8051.  Bit7: 1: The power control signal to AFE will be auto controlled by suspendm.
0Ch	RFChipID	RF Chip ID. The identifier of the RF chip.

Bytes	Contents	Description
0Dh	CONFIG3	RTL8187L Configuration register 3. Operational register FF59h.
0Eh~13h	MAC Address	MAC Address. After the auto-load command or a hardware reset, the RTL8187L loads MAC Addresses to IDR0~IDR5 of the I/O registers of the RTL8187L.
14h	-	Reserved.
15h	CONFIG1	RTL8187L Configuration register 1. Operational register FF52h.
16h~17h	CRC	16-bit CRC value of EEPROM content.
18h	CONFIG2	RTL8187L Configuration register 2. Operational register FF53h.
19h	CONFIG4	RTL8187L Configuration register 4. Operational register FF5Ah.
1Ah~1Dh	ANA_PARM	Analog Parameter for the RTL8187L. Operational registers of the RTL8187L are from FF54h to FF57h. Reserved. Do not change this field without Realtek approval.
1Eh	TESTR	RTL8187L Test Mode Register. Operational register FF5Bh. Reserved. Do not change this field without Realtek approval.
1Fh	-	Reserved.
20h	OFDM_TxPower 1	Transmit Power Level for 802.11a-defined channel_ID 36 (Center frequency=5180MHz).
21h	OFDM_TxPower 2	Transmit Power Level for 802.11a-defined channel_ID 40 (Center frequency=5200MHz).
22h	OFDM_TxPower 3	Transmit Power Level for 802.11a-defined channel_ID 44 (Center frequency=5220MHz).
23h	OFDM_TxPower 4	Transmit Power Level for 802.11a-defined channel_ID 48 (Center frequency=5240MHz).
24h	OFDM_TxPower 5	Transmit Power Level for 802.11a-defined channel_ID 52 (Center frequency=5260MHz).
25h	OFDM_TxPower 6	Transmit Power Level for 802.11a-defined channel_ID 56 (Center frequency=5280MHz).
26h	OFDM_TxPower 7	Transmit Power Level for 802.11a-defined channel_ID 60 (Center frequency=5300MHz).
27h	OFDM_TxPower 8	Transmit Power Level for 802.11a-defined channel_ID 64 (Center frequency=5320MHz).
28h	OFDM_TxPower 9	Transmit Power Level for 802.11a-defined channel_ID 149 (Center frequency=5745MHz).
29h	OFDM_TxPower 10	Transmit Power Level for 802.11a-defined channel_ID 153 (Center frequency=5765MHz).
2Ah	OFDM_TxPower 11	Transmit Power Level for 802.11a-defined channel_ID 157 (Center frequency=5785MHz).
2Bh	OFDM_TxPower 12	Transmit Power Level for 802.11a-defined channel_ID 161 (Center frequency=5805MHz).
2Ch	CCK_TxPower1	Transmit Power Level for 802.11b(g)-defined channel_ID 1 (center frequency=2412MHz).



Bytes	Contents	Description
2Dh	CCK_TxPower2	Transmit Power Level for 802.11b(g)-defined channel_ID 2 (center frequency=2417MHz).
2Eh	CCK_TxPower3	Transmit Power Level for 802.11b(g)-defined channel_ID 3 (center frequency=2422MHz).
2Fh	CCK_TxPower4	Transmit Power Level for 802.11b(g)-defined channel_ID 4 (center frequency=2427MHz).
30h	CCK_TxPower5	Transmit Power Level for 802.11b(g)-defined channel_ID 5 (center frequency=2432MHz).
31h	CCK_TxPower6	Transmit Power Level for 802.11b(g)-defined channel_ID 6 (center frequency=2437MHz).
32h-35h	ANA_PARM2	Reserved: Do not change this field without Realtek approval. Analog Parameter1 for the RTL8187L: Operational registers of the RTL8187L are from FF60h to FF63h.
36h	CCK_TxPower11	Transmit Power Level for 802.11b(g)-defined channel_ID 11 (center frequency=2462MHz).
37h	CCK_TxPower12	Transmit Power Level for 802.11b(g)-defined channel_ID 12 (center frequency=2467MHz).
38h	CCK_TxPower13	Transmit Power Level for 802.11b(g)-defined channel_ID 13 (center frequency=2472MHz).
39h	CCK_TxPower14	Transmit Power Level for 802.11b(g)-defined channel_ID 14 (center frequency=2484MHz).
3Ah-6Bh	Manufacture String & Product String	Manufacture String and Product String: Those bits specify both manufacturer's information and device's information for the USB standard request. Maximum two strings total length are 50 bytes.
6Ch-79h	-	Reserved.
7Ah	CCK_TxPower7	Transmit Power Level for 802.11b(g)-defined channel_ID 7 (center frequency=2442MHz).
7Bh	CCK_TxPower8	Transmit Power Level for 802.11b(g)-defined channel_ID 8 (center frequency=2447MHz).
7Ch	CCK_TxPower9	Transmit Power Level for 802.11b(g)-defined channel_ID 9 (center frequency=2452MHz).
7Dh	CCK_TxPower10	Transmit Power Level for 802.11b(g)-defined channel_ID 10 (center frequency=2457MHz).

## 9.1. EEPROM Registers Summary

**Table 25. EEPROM Registers Summary**

Address	Name	Type	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
FF00h-FF05h	IDR0 – IDR5	R/W*								
FF52h	CONFIG1	R	LEDS1	LEDS0	-	LWACT	-	-	-	-
		W*	LEDS1	LEDS0	-	LWACT	-	-	-	-
FF53h	CONFIG2	R	LCK	-	-	-	-	PAPE _sign	PAPE _time	
		W*	-	-	-	-	-	PAPE _sign	PAPE _time	
FF54h-FF57h	ANA_PARM	R/W**	32-bit Read Write							
FF59h	CONFIG3	R	-	PARM_En	Magic	-	-	-	-	-
		W*	-	PARM_En	Magic	-	-	-	-	-
FF5Ah	CONFIG4	R	-	-	-	LWPME	-	LWPTN	-	
		W*	-	-	-	LWPME	-	LWPTN	-	
FF5Bh	TESTR		8-bit Read Write							
FF60h-FF63h	ANA_PARM2	R/W	32-bit Read Write							
FFD8h	CONFIG5	R/W**	-	-	-	-	-	-	LANWake	-

Note 1: Registers marked 'W\*' can be written only if bits EEM1=EEM0=1.

Note 2: Registers marked 'W\*\*' can be written only if bits EEM1:0=[1:1] and CONFIG3<PARM\_EN>= 0.

## 9.2. EEPROM Power Management Registers Summary

**Table 26. EEPROM Power Management Registers Summary**

Configuration Space Offset	Name	Type	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
52h	PMC	R	Aux_I_b1	Aux_I_b0	DSI	Reserved	PMECLK	Version		
53h		R	PME_D3_cold	PME_D3_hot	PME_D2	PME_D1	PME_D0	D2	D1	Aux_I_b2

## 10. USB Packet Buffering

The RTL8187L incorporates two independent FIFOs for transferring data to/from the system interface and from/to the network. The FIFOs provide temporary storage of data, freeing the host system from the real-time demands of the network.

The way in which the FIFOs are emptied and filled is controlled by the FIFO threshold values in the Receive Configuration registers. These values determine how full or empty the FIFOs must be before the device requests the bus. Once the RTL8187L requests the bus, it will attempt to empty or fill the FIFOs as allowed by the respective MXDMA settings in the Transmit Configuration and Receive Configuration registers.

### *10.1. Transmit Buffer Manager*

The buffer management scheme used on the RTL8187L allows quick, simple, and efficient use of the frame buffer memory. The buffer management scheme uses separate buffers and descriptors for packet information. This allows effective transfers of data to the transmit buffer manager by simply transferring the descriptor information to the transmit queue.

The Tx Buffer Manager DMA's packet data from system memory and places it in the 3.5KB transmit FIFO, and pulls data from the FIFO to send to the Tx MAC. Multiple packets may be present in the FIFO, allowing packets to be transmitted with Short InterFrame (SIF) space. Additionally, once the RTL8187L requests the bus, it will attempt to fill the FIFO as allowed by the MXDMA setting.

The Tx Buffer Manager process also supports priority queuing of transmit packets. It handles this by drawing from two separate descriptor lists to fill the internal FIFO. If packets are available in the high priority queues, they will be loaded into the FIFO before those of low priority.

### *10.2. Receive Buffer Manager*

The Rx Buffer Manager uses the same buffer management scheme as used for transmits. The Rx Buffer Manager retrieves packet data from the Rx MAC and places it in the 4KB receive data FIFO, and pulls data from the FIFO for DMA to system memory. The receive FIFO is controlled by the FIFO threshold value in RXFTH. This value determines the number of long words written into the FIFO from the MAC unit before a DMA request for system memory occurs. Once the RTL8187L gets the bus, it will continue to transfer the long words from the FIFO until the data in the FIFO is less than one long word, or has reached the end of the packet, or the max DMA burst size is reached, as set in MXDMA.

### *10.3. Packet Recognition*

The Rx packet filter and recognition logic allows software to control which packets are accepted, based on destination address and packet type. Address recognition logic includes support for broadcast, multicast hash, and unicast addresses. The packet recognition logic includes support for WOL and programmable pattern recognition.

## 11. Functional Description

### 11.1. Transmit & Receive Operations

The RTL8187L supports a new descriptor-based buffer management that will significantly lower host CPU utilization. The RTL8187L supports transmit descriptor and receive descriptor in memory. Each OUT packet contains 3-double-word transmit descriptors and each IN packet contains 4-double-word receive descriptors.

#### 11.1.1. Transmit

##### Tx Descriptor Format

**Table 27. Tx Descriptor Format**

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
RSVD				TXRATE (4 bits)				RTSEEN	RTSRATE (4 bits)				CTSEEN	MSRLEN	SOPT	RSVD				TPKTSIZE (12 bits)												Offset 0
L E N G T H	Length (15 bits)															RTSDUR (16 bits)											Offset 4					
	RATE_FALLBACK_LIMIT (4 bits)			RSVD			ANTENNA			AGC (8 bits)				RETRY_LIMIT (8 bits)				CWMAX (4 bits)				CWMIN (4 bits)				Offset 8						

**Table 28. Tx Status Descriptor**

Offset#	Bit#	Symbol	Description				
0	31:28	RSVD	Reserved.				
0	27:24	TXRATE	Tx Rate. These four bits indicate the current frame's transmission rate.				
				<b>Bit 27</b>	<b>Bit 26</b>	<b>Bit 25</b>	<b>Bit 24</b>
			1Mbps	0	0	0	0
			2Mbps	0	0	0	1
			5.5Mbps	0	0	1	0
			11Mbps	0	0	1	1
			6Mbps	0	1	0	0
			9Mbps	0	1	0	1
			12Mbps	0	1	1	0
			18Mbps	0	1	1	1
			24Mbps	1	0	0	0
			36Mbps	1	0	0	1
			48Mbps	1	0	1	0
			54Mbps	1	0	1	1
			Reserved	All other combinations			
			0	23	RTSEN	RTS Enable. Set to 1 indicates that an RTS/CTS handshake shall be performed at the beginning of any frame exchange sequence where the frame is of type Data or Management, the frame has a unicast address in the Address1 field, and the length of the frame is greater than RTSThreshold.	
0	22:19	RTSRATE	RTS Rate. These four bits indicate the RTS frame's transmission rate before transmitting the current frame and will be ignored if the RTSEN bit is set to 0.				
				<b>Bit 22</b>	<b>Bit 21</b>	<b>Bit 20</b>	<b>Bit 19</b>
			1Mbps	0	0	0	0
			2Mbps	0	0	0	1
			5.5Mbps	0	0	1	0
			11Mbps	0	0	1	1
			6Mbps	0	1	0	0
			9Mbps	0	1	0	1
			12Mbps	0	1	1	0
			18Mbps	0	1	1	1
			24Mbps	1	0	0	0
			36Mbps	1	0	0	1
			48Mbps	1	0	1	0
			54Mbps	1	0	1	1
			Reserved	All other combinations			
			0	18	CTSEN	CTS Enable. Both RTSEN and CTSEN set to 1 indicates that the CTS-to-Self protection mechanism will be used.	

Offset#	Bit#	Symbol	Description
0	17	MOREFRAG	More Fragment. This bit is set to 1 in all data type frames that have another fragment of the current packet to follow.
0	16	SPLCP	Short Physical Layer Convergence Protocol format. When set, this bit indicates that a short PLCP preamble will be added to the header before transmitting the frame.
0	15	NO_ENCRYPT	No Encryption. This packet will be sent out without encryption even if Tx encryption is enabled.
0	14:12	RSVD	Reserved.
0	11:0	TPKTSIZE	Transmit Packet Size. This field indicates the number of bytes required to transmit the frame.
4	31	LENGEXT	Length Extension. This bit is used to supplement the Length field (bits 30:16, offset 4). This bit will be ignored if the TXRATE is set to 1Mbps, 2Mbps, or 5.5Mbps.
4	30:16	Length	PLCP Length. The PLCP length field indicates the number of microseconds required to transmit the frame.
4	15:0	RTSDUR	RTS Duration. These bits indicate the RTS frame's duration field before transmitting the current frame and will be ignored if the RTSEN bit is set to 0.
8	31:28	RATE_FALL BACK_LIMIT	Data Rate Auto Fallback Limit.
8	27:25	RSVD	Reserved.
8	24	ANTENNA	Tx Antenna.
8	23:16	AGC	Tx AGC.
8	15:8	RETRY_LIMIT	Retry Count Limit.
8	7:4	CWMAX	Maximum Contention Window.
8	3:0	CWMIN	Minimum Contention Window.

## 11.1.2. Receive

### Rx Descriptor Format

**Table 29. Rx Descriptor Format**

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RSVD				D M A F	F A V F	S O P L C P	R S V D	RXRATE (4 bits)				R S V D	M A V R	P A R M	B A R	R E S	P W R M G T	C R C 3 2	I C V	Frame_Length (12 bits)								Offset 0			
RSVD (6 bits)					W A K E U P	D E K E Y P T E D	AGC (8 bits)						A N T E N N A	RSSI (7 bits)				SQ (8 bits)				Offset 4									
																TSFTL												Offset 8			
																TSFTH												Offset 12			

**Table 30. Rx Status Descriptor**

Offset#	Bit#	Symbol	Description
0	31:28	RSVD	Reserved.
0	27	DMAF	RX DMA Fail. When set, this packet will be dropped by software.
0	26	FOVF	FIFO Overflow. When set, this bit indicates that the receive FIFO was exhausted before this packet was fully received.
0	25	SPLCP	Short Physical Layer Convergence Protocol format. When set, this bit indicates that a short PLCP preamble was added to the current received frame.
0	24	RSVD	Reserved.

Offset#	Bit#	Symbol	Description				
0	23:20	RXRATE	Rx Rate. These four bits indicate the current frame's receiving rate.				
				<b>Bit 23</b>	<b>Bit 22</b>	<b>Bit 21</b>	<b>Bit 20</b>
			1Mbps	0	0	0	0
			2Mbps	0	0	0	1
			5.5Mbps	0	0	1	0
			11Mbps	0	0	1	1
			6Mbps	0	1	0	0
			9Mbps	0	1	0	1
			12Mbps	0	1	1	0
			18Mbps	0	1	1	1
			24Mbps	1	0	0	0
			36Mbps	1	0	0	1
			48Mbps	1	0	1	0
			54Mbps	1	0	1	1
	Reserved	All other combinations					
0	19	RSVD	Reserved.				
0	18	MAR	Multicast Address Packet Received. When set, this bit indicates that a multicast packet was received.				
0	17	PAM	Physical Address Matched. When set, this bit indicates that the destination address of this Rx packet matches the value in the RTL8187L's ID registers.				
0	16	BAR	Broadcast Address Received. When set, this bit indicates that a broadcast packet was received. BAR and MAR will not be set simultaneously.				
0	15	RES	Receive Error. Valid if DMAF=0				
0	14	PWRMGT	Receive Power Management Packet. When set, this bit indicates that the Power Management bit is set on the received packet.				
0	13	CRC32	CRC32 Error. When set, this bit indicates that a CRC32 error has occurred on the received packet. A CRC32 packet can be received only when RCR_ACRC32 is set.				
0	12	ICV	Integrity Check Value Error. When set, this bit indicates that an ICV error has occurred on the received packet. A ICV packet can be received only when RCR_AICV is set.				
0	11:0	Frame_Length	This bit indicates the received packet length including CRC32, in bytes.				
4	31:26	RSVD	Reserved.				
4	25	WAKEUP	The received packet is a unicast wakeup packet.				
4	24	DECRYPTED	The received packet has been decrypted.				
4	23:16	AGC	The AGC of the received packet.				
4	15	ANTENNA	The received packet is received through this antenna.				
4	14:8	RSSI	Received Signal Strength Indicator. The RSSI is a measure of the RF energy received by the PHY.				



Offset#	Bit#	Symbol	Description
4	7:0	SQ	Signal Quality. The SQ is a measure of the quality of BAKER code lock, providing an effective measure during the full reception of a PLCP preamble and header.
8	31:0	TSFTL	A snapshot of the TSFTR's least significant 32 bits.
12	31:0	TSFTH	A snapshot of the TSFTR's most significant 32 bits.

## ***11.2. Loopback Operation***

Loopback mode is normally used to verify that the logic operations have performed correctly. In loopback mode, the RTL8187L takes frames from the transmit descriptor and transmits them up to internal Rx logic. The loopback function does not apply to an external PHYceiver.

## ***11.3. Tx Encapsulation (With RTL8187L Internal Baseband Processor)***

While operating in Tx mode, the RTL8187L encapsulates the frames that it transmits according to the Differential Binary Phase Shift Keying (DBPSK) for 1Mbps, Differential Quaternary Phase Shift Keying (DQPSK) for 2Mbps, and Complementary Code Keying (CCK) for 5.5Mbps and 11Mbps modulators. The changes to the original packet data are as follows:

1. The PLCP preamble is always transmitted as the DBPSK waveform and used by the receiver to achieve initial PN synchronization.
2. The PLCP header can be configured to be either DBPSK or DQPSK and includes the necessary data fields of the communications protocol to establish the physical layer link.
3. The MAC frame can be configured for DBPSK, DQPSK, or CCK.

## ***11.4. Rx Decapsulation (With RTL8187L Internal Baseband Processor)***

The RTL8187L continuously monitors the network when reception is enabled. When activity is recognized it starts to process the incoming data. After detecting receive activity on the channel, the RTL8187L starts to process the PLCP preamble and header based on the mode of operation.

The RTL8187L checks CRC16 and CRC32, then reports if CRC16 or CRC32 has errors. When using the 40-bit WEP and 104-bit WEP module for decryption, the RTL8187L also checks the Integrity Check Value (ICV) and reports if the ICV has errors.

## 11.5. LED Functions

The RTL8187L supports 2 LED signals in 4 configurable operation modes. The following sections describe the different LED actions.

### 11.5.1. Link Monitor

The Link Monitor senses the link integrity. Whenever link status is established, the specific link LED pin is driven low.

### 11.5.2. Infrastructure Monitor

The Infrastructure Monitor senses the link integrity of an Infrastructure network. Whenever Link OK in Infrastructure network status is established, the specific Infrastructure LED pin is driven low.

### 11.5.3. Rx LED

Blinking of the Rx LED indicates that receive activity is occurring.

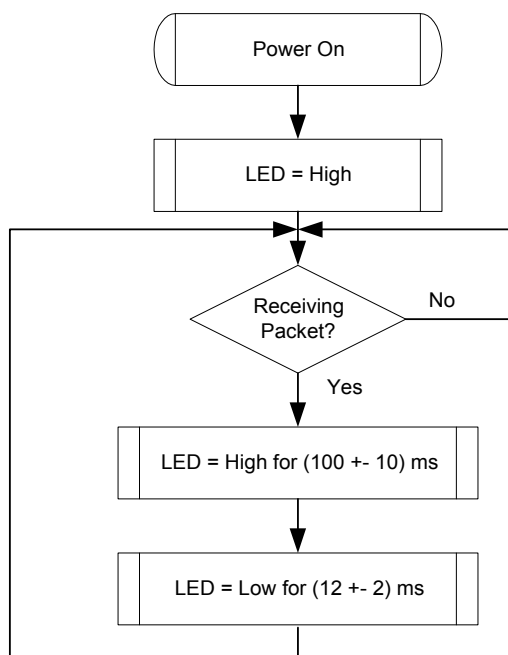
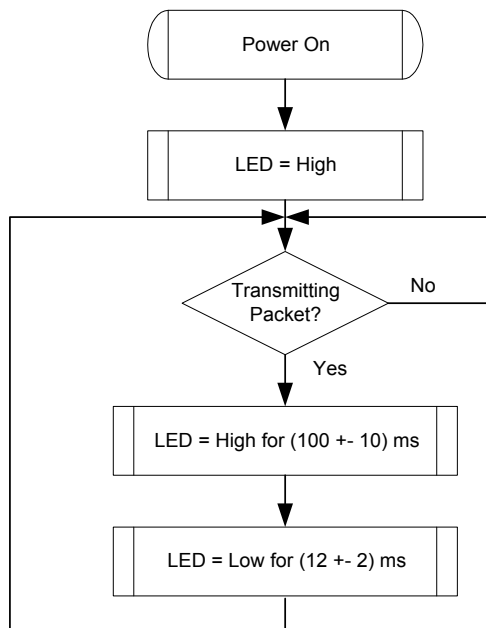


Figure 3. Rx LED

### 11.5.4. Tx LED

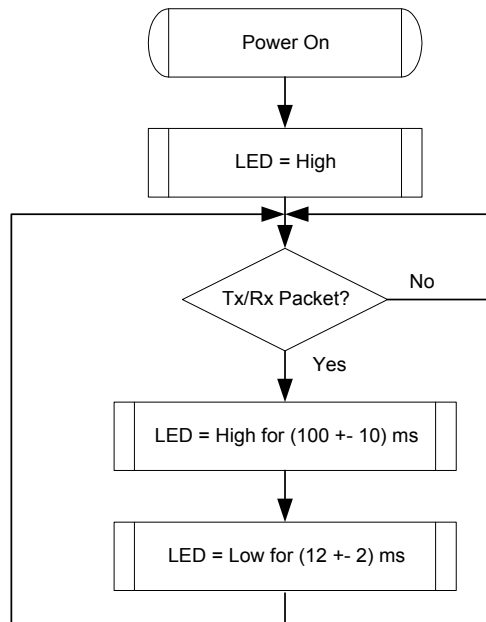
Blinking of the Tx LED indicates that transmit activity is occurring.



**Figure 4. Tx LED**

### 11.5.5. Tx/Rx LED

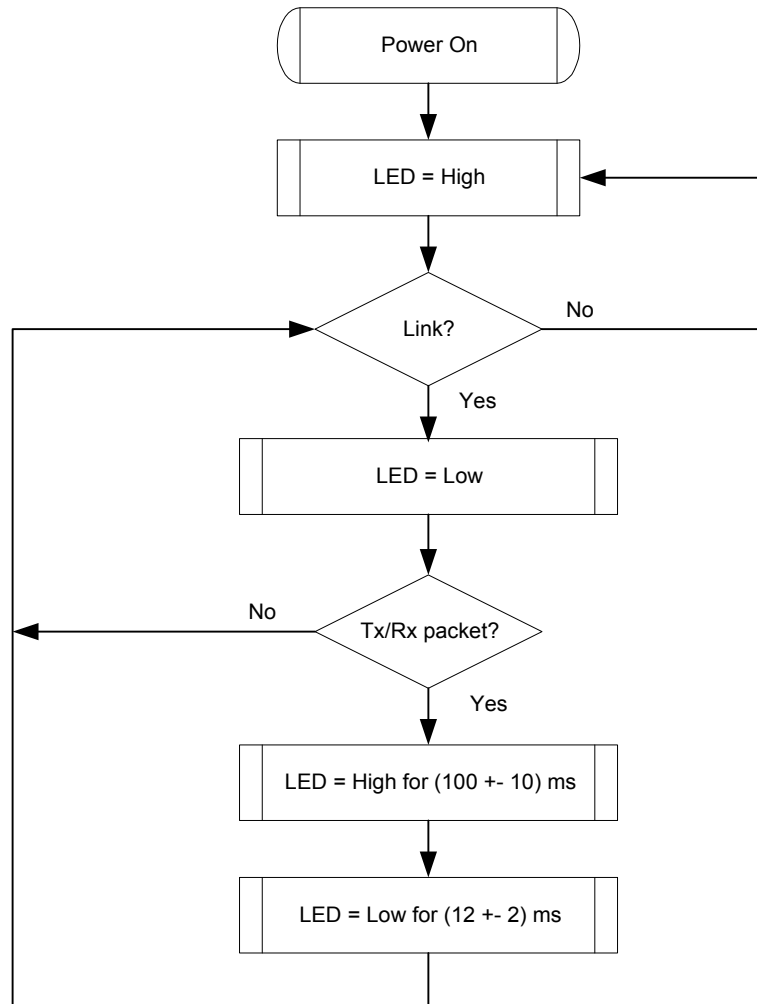
Blinking of the Tx/Rx LED indicates that both transmit and receive activity is occurring.



**Figure 5. Tx/Rx LED**

### 11.5.6. LINK/ACT LED

Blinking of the LINK/ACT LED indicates that the RTL8187L is linked and operating properly. If this LED is high for extended periods it indicates that a link problem exists.



**Figure 6. LINK/ACT LED**

## 12. Application Diagram

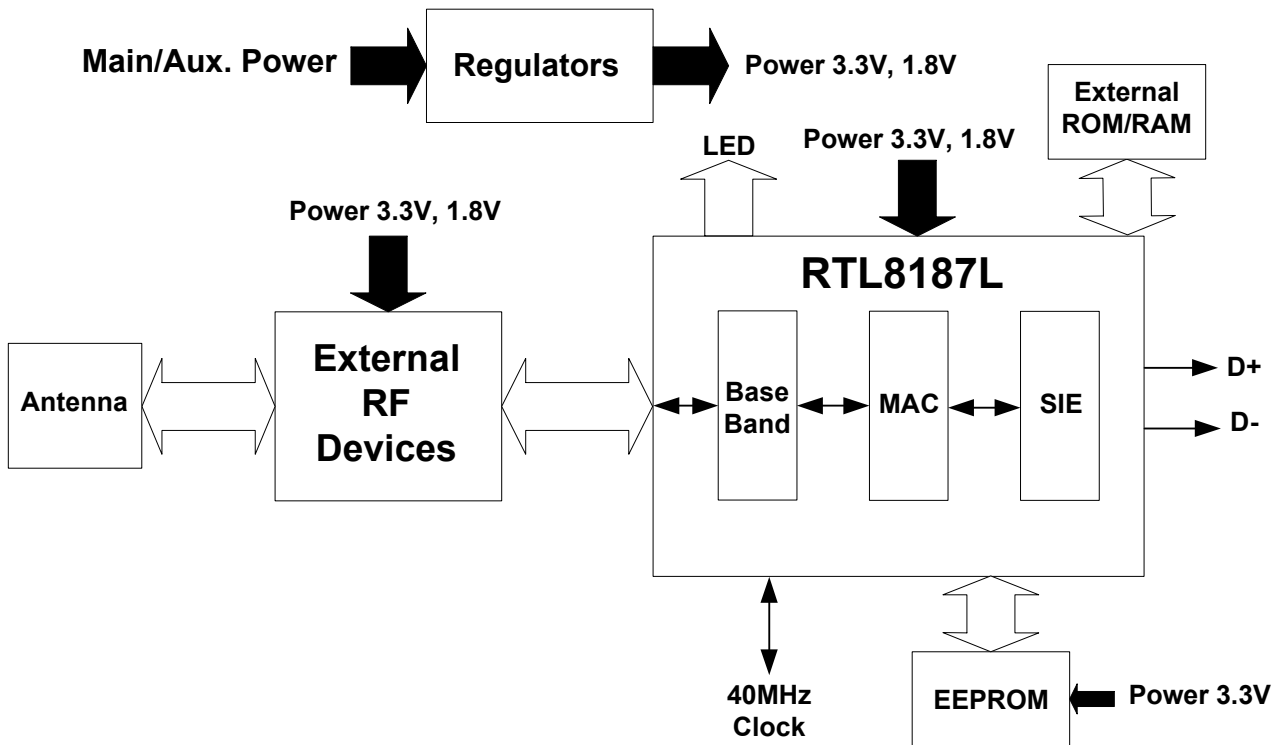


Figure 7. Application Diagram

## 13. Electrical Characteristics

### 13.1. Temperature Limit Ratings

**Table 31. Temperature Limit Ratings**

Parameter	Minimum	Maximum	Units
Storage temperature	-55	+125	°C
Operating temperature	-10	70	°C

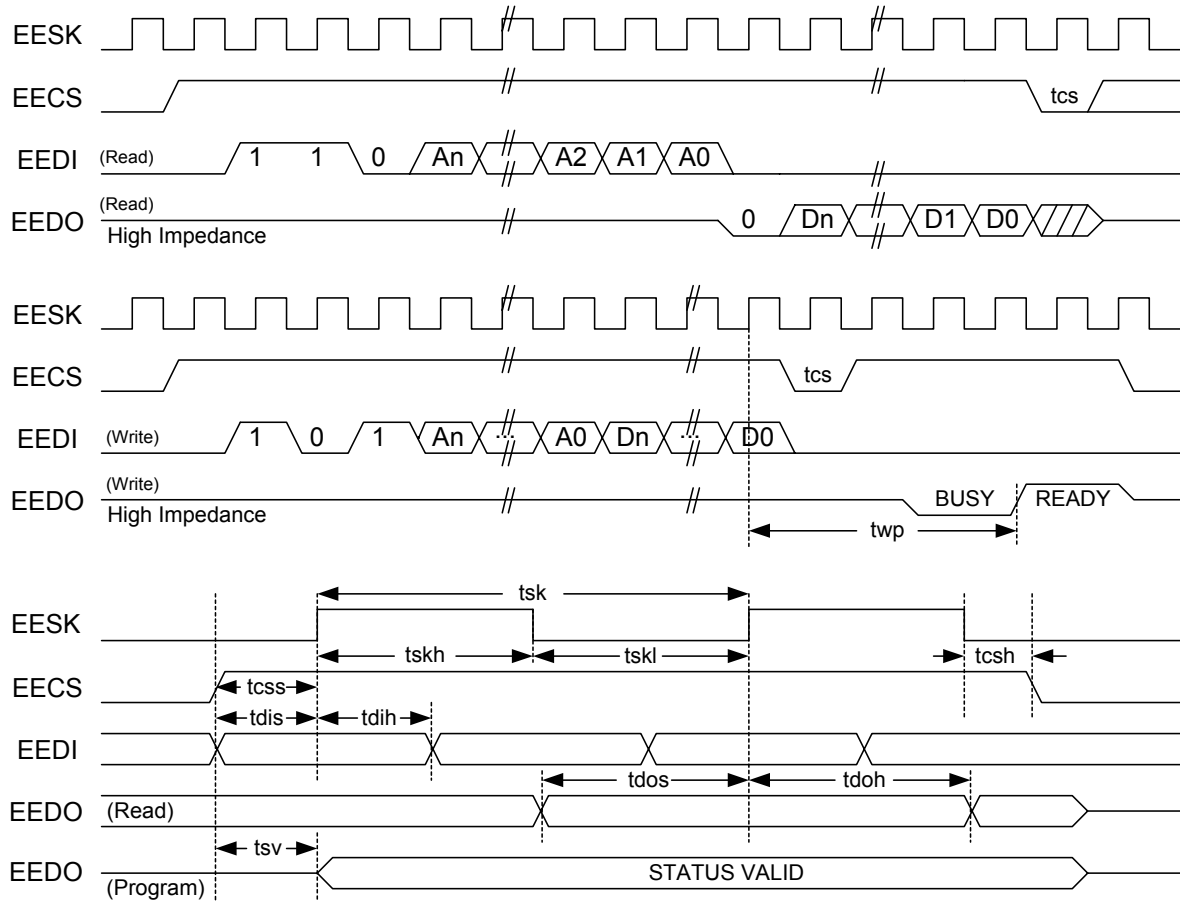
### 13.2. DC Characteristics

**Table 32. DC Characteristics**

Symbol	Parameter	Conditions	Minimum	Typical	Maximum	Units
VDD33	3.3V Supply Voltage		3.0	3.3	3.6	V
VDD18	1.8V Supply Voltage		1.7	1.8	1.9	V
V <sub>oh</sub>	Minimum High Level Output Voltage	I <sub>oh</sub> = -8mA	0.9 * V <sub>cc</sub>		V <sub>cc</sub>	V
V <sub>ol</sub>	Maximum Low Level Output Voltage	I <sub>ol</sub> = 8mA			0.1 * V <sub>cc</sub>	V
V <sub>ih</sub>	Minimum High Level Input Voltage		0.5 * V <sub>cc</sub>		V <sub>cc</sub> +0.5	V
V <sub>il</sub>	Maximum Low Level Input Voltage		-0.5		0.3 * V <sub>cc</sub>	V
I <sub>in</sub>	Input Current	V <sub>in</sub> = V <sub>cc</sub> or GND	-1.0		1.0	μA
I <sub>oz</sub>	Tri-State Output Leakage Current	V <sub>out</sub> = V <sub>cc</sub> or GND	-10		10	μA
I <sub>cc</sub>	Average Operating Supply Current	I <sub>out</sub> = 0mA,			460	mA

### 13.3. AC Characteristics

#### 13.3.1. Serial EEPROM Interface Timing (93C46(64\*16)/93C56(128\*16))

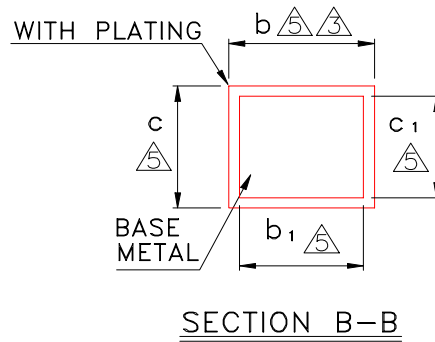
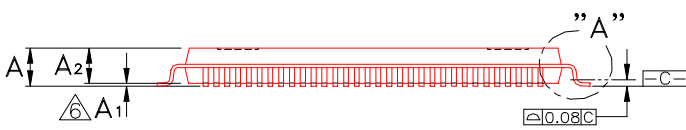
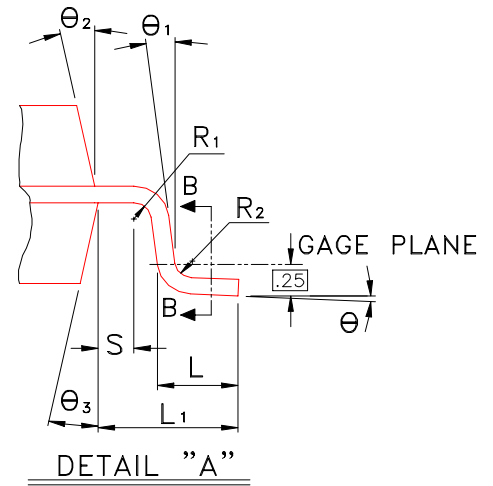
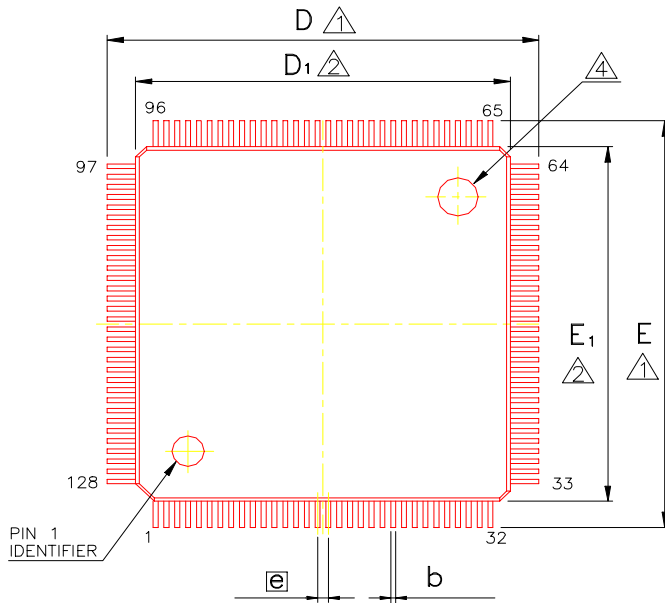


**Figure 8. Serial EEPROM Interface Timing**

**Table 33. EEPROM Access Timing Parameters**

Symbol	Parameter		Minimum	Typical	Maximum	Units
tcs	Minimum CS Low Time	9346/9356	1000/250			ns
twp	Write Cycle Time	9346/9356			10/10	ms
tsk	SK Clock Cycle Time	9346/9356	4/1			μs
tskh	SK High Time	9346/9356	1000/500			ns
tskl	SK Low Time	9346/9356	1000/250			ns
tcsh	CS Hold Time	9346/9356	0/0			ns
tcshh	CS Setup Time	9346/9356	200/50			ns
tdis	DI Setup Time	9346/9356	400/50			ns
tdih	DI Hold Time	9346/9356	400/100			ns
tdos	DO Setup Time	9346/9356	2000/500			ns
tdoh	DO Hold Time	9346/9356			2000/500	ns
tsv	CS to Status Valid	9346/9356			1000/500	ns

# 14. Mechanical Dimensions



See the Mechanical Dimensions notes on the next page.



### 14.1. Mechanical Dimensions Notes

Symbol	Dimension in inch			Dimension in mm		
	Min	Typical	Max	Min	Typical	Max
<b>A</b>	-	-	0.063	-	-	1.60
<b>A<sub>1</sub></b>	0.002	-	-	0.05	-	-
<b>A<sub>2</sub></b>	0.053	0.055	0.057	1.35	<b>1.40</b>	1.45
<b>b</b>	0.005	0.007	0.009	0.13	<b>0.18</b>	0.23
<b>c</b>	0.004	-	0.006	0.09	-	0.20
<b>D</b>	0.624	0.630	0.636	15.85	<b>16.00</b>	16.15
<b>D<sub>1</sub></b>	0.547	0.551	0.555	13.90	<b>14.00</b>	14.10
<b>e</b>	0.016 BSC			0.40 BSC		
<b>E</b>	0.624	0.630	0.636	15.85	<b>16.00</b>	16.15
<b>E<sub>1</sub></b>	0.547	0.551	0.555	13.90	<b>14.00</b>	14.10
<b>L</b>	0.018	0.024	0.030	0.45	<b>0.60</b>	0.75
<b>L<sub>1</sub></b>	0.039 REF			1.00 REF		
<b>Θ</b>	0°	3.5°	7°	0°	3.5°	7°

Note:

- 1.Dimension b does not include dambar protrusion/intrusion.
- 2.Controlling dimension: Millimeter
- 3.General appearance spec. should be based on final visual inspection spec.

TITLE: 128LD LQFP ( 14x14x1.4 mm*2 ) PACKAGE OUTLINE -CU L/F, FOOTPRINT 2.0 mm		
LEADFRAME MATERIAL:		
APPROVE	DOC. NO.	530-ASS-P004
	VERSION	1
	PAGE	OF
CHECK	DWG NO.	LQ128 - 2
	DATE	MAY. 13.2002
<b>REALTEK SEMICONDUCTOR CORP.</b>		

## 15. Ordering Information

**Table 34. Ordering Information**

<b>Part Number</b>	<b>Package</b>	<b>Status</b>
RTL8187L	128-pin LQFP	MP
RTL8187L-LF	RTL8187L with Lead (Pb)-Free package	MP

---

**Realtek Semiconductor Corp.****Headquarters**

No. 2, Industry East Road IX, Science-based  
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Tel: 886-3-5780211 Fax: 886-3-5776047

[www.realtek.com.tw](http://www.realtek.com.tw)



## Test Report

REALTEK SEMICONDUCTOR CORP  
NO. 2, INNOVATION ROAD II, SCIENCE PARK, HSINCHU  
300, TAIWAN

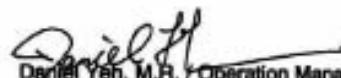
Report No. : CE/2005/74949  
Date : 2005/07/27  
Page : 1 of 4

The following merchandise was (were) submitted and identified by the client as :

Type of Product : LQFP128-LF  
Style/Item No : RTL8187L  
Sample Received : 2005/07/22  
Testing Date : 2005/07/22 TO 2005/07/27

=====

Test Result : - Please see the next page -

  
Daniel Yen, M.R. / Operation Manager  
Signed for and on behalf of  
SGS TAIWAN LTD.

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## Test Report

REALTEK SEMICONDUCTOR CORP  
NO. 2, INNOVATION ROAD II, SCIENCE PARK, HSINCHU  
300, TAIWAN

Report No. : CE/2005/74949  
Date : 2005/07/27  
Page : 2 of 4

### Test Result

PART NAME NO.1 : MIXED ALL PARTS(IC) (PLEASE REFER TO THE PHOTO ATTACHED)

Test Item (s):	Unit	Method	MDL	Result
				No.1
Monobromobiphenyl	%	With reference to USEPA8540C or USEPA8550C. Analysis was performed by HPLC/DAD, LC/MS or GC/MS. (prohibited by 2002/95/EC (RoHS), 83/264/EEC, and 76/769/EEC)	0.0005	N.D.
Dibromobiphenyl	%		0.0005	N.D.
Tribromobiphenyl	%		0.0005	N.D.
Tetrabromobiphenyl	%		0.0005	N.D.
Pentabromobiphenyl	%		0.0005	N.D.
Hexabromobiphenyl	%		0.0005	N.D.
Heptabromobiphenyl	%		0.0005	N.D.
Octabromobiphenyl	%		0.0005	N.D.
Nonabromobiphenyl	%		0.0005	N.D.
Decabromobiphenyl	%		0.0005	N.D.
<b>Total PBBs(Polybrominated biphenyls)/ Sum of above</b>	%		-	N.D.
Monobromobiphenyl ether	%		With reference to USEPA8540C or USEPA8550C. Analysis was performed by HPLC/DAD, LC/MS or GC/MS. (prohibited by 2002/95/EC (RoHS), 83/264/EEC, and 76/769/EEC)	0.0005
Dibromobiphenyl ether	%	0.0005		N.D.
Tribromobiphenyl ether	%	0.0005		N.D.
Tetrabromobiphenyl ether	%	0.0005		N.D.
Pentabromobiphenyl ether	%	0.0005		N.D.
Hexabromobiphenyl ether	%	0.0005		N.D.
Heptabromobiphenyl ether	%	0.0005		N.D.
Octabromobiphenyl ether	%	0.0005		N.D.
Nonabromobiphenyl ether	%	0.0005		N.D.
Decabromobiphenyl ether	%	0.0005		N.D.
<b>Total PBDEs(PBDEs) (Polybrominated biphenyl ethers)/ Sum of above</b>	%	-		N.D.

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Report No. : CE/2005/74949  
Date : 2005/07/27  
Page : 3 of 4

Test Item (s):	Unit	Method	MDL	Result
				No.1
Chromium VI (Cr <sup>+6</sup> )	ppm	UV-VIS after reference to US EPA 8060A.	2	N.D.
Cadmium (Cd)	ppm	ICP-AES after reference to EN 1122, method B:2001 or other acid digestion.	2	N.D.
Mercury (Hg)	ppm	ICP-AES after reference to US EPA 8052 or other acid digestion.	2	N.D.
Lead (Pb)	ppm	ICP-AES after reference to US EPA 8050B or other acid digestion.	2	N.D.

NOTE: (1) N.D. = Not detected (<MDL)  
(2) ppm = mg/kg  
(3) MDL = Method Detection Limit  
(4) " - " = No Regulation

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